


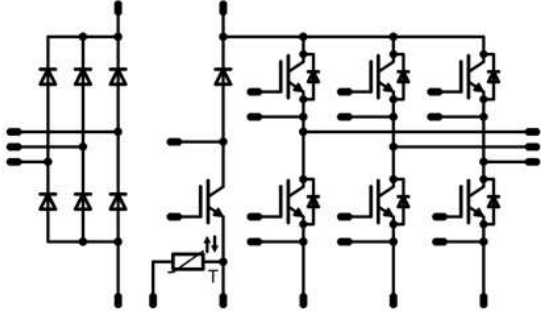
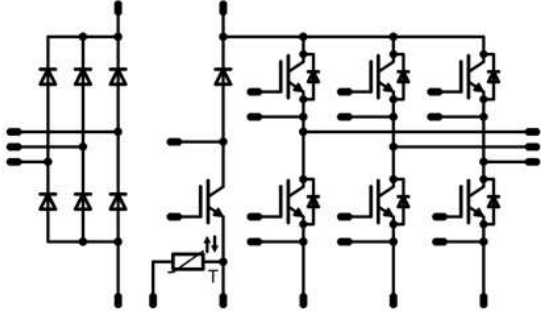
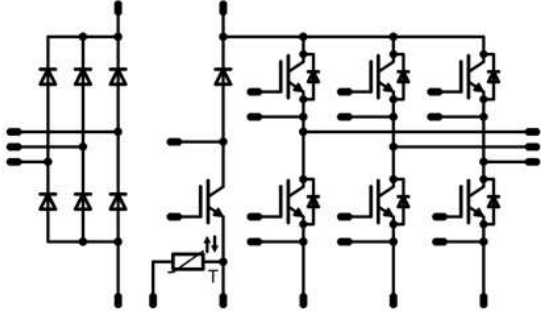




| <i>flow90PIM 1</i> | 600 V / 20 A | | | | |
|--|---------------------|---|---|------------------------|---|
| <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr style="background-color: #ccc;"> <th style="text-align: center; padding: 2px;">Features</th> </tr> </thead> <tbody> <tr> <td style="padding: 2px;"> <ul style="list-style-type: none"> Trench Fieldstop Technology IGBT3 for low saturation loss Supports design with 90° mounting angle between heatsink and PCB Clip-in PCB mounting Clip or screw on heatsink mounting </td> </tr> </tbody> </table> | Features | <ul style="list-style-type: none"> Trench Fieldstop Technology IGBT3 for low saturation loss Supports design with 90° mounting angle between heatsink and PCB Clip-in PCB mounting Clip or screw on heatsink mounting | <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr style="background-color: #ccc;"> <th style="text-align: center; padding: 2px;"><i>flow 90 housing</i></th> </tr> </thead> <tbody> <tr> <td style="text-align: center; padding: 5px;">  </td> </tr> </tbody> </table> | <i>flow 90 housing</i> |  |
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| Types | | | | | |
| <ul style="list-style-type: none"> V23990-P634-A-PM | | | | | |

Maximum Ratings

$T_j=25^{\circ}\text{C}$, unless otherwise specified

| Parameter | Symbol | Condition | Value | Unit |
|-----------------------------------|----------------------|---|----------|--------------------|
| Inverter switch | | | | |
| Collector-emitter voltage | V_{CES} | | 600 | V |
| Collector current | I_C | $T_j=T_{jmax}$ $T_S=80^{\circ}\text{C}$ | 24 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 60 | A |
| Total power dissipation | P_{tot} | $T_j=T_{jmax}$ $T_S=80^{\circ}\text{C}$ | 53 | W |
| Gate-emitter voltage | V_{GES} | | ±20 | V |
| Short circuit ratings | t_{SC} V_{CC} | $T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$ | 6 360 | μs V |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}\text{C}$ |



| Parameter | Symbol | Conditions | Value | Unit |
|-------------------------------------|------------|----------------------------------|-------|-------------|
| Inverter Diode | | | | |
| Peak Repetitive Reverse Voltage | V_{RRM} | | 600 | V |
| Continuous (direct) forward current | I_F | $T_j=T_{jmax}$ $T_h=80^{\circ}C$ | 24 | A |
| Repetitive peak forward current | I_{FRM} | | 40 | A |
| Total power dissipation | P_{tot} | $T_j=T_{jmax}$ $T_h=80^{\circ}C$ | 40 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}C$ |

| Parameter | Symbol | Condition | Value | Unit |
|-----------------------------------|------------|----------------------------------|----------|-------------|
| Brake switch | | | | |
| Collector-emitter voltage | V_{CES} | | 600 | V |
| Collector current | I_C | $T_j=T_{jmax}$ $T_s=80^{\circ}C$ | 20 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by T_{jmax} | 45 | A |
| Total power dissipation | P_{tot} | $T_j=T_{jmax}$ $T_s=80^{\circ}C$ | 47 | W |
| Gate-emitter voltage | V_{GES} | | ± 20 | V |
| Short circuit ratings | t_{SC} | $T_j \leq 150^{\circ}C$ | 6 | μs |
| | V_{CC} | $V_{GE} = 15V$ | 360 | V |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}C$ |

| Parameter | Symbol | Conditions | Value | Unit |
|-------------------------------------|------------|----------------------------------|-------|-------------|
| Brake Diode | | | | |
| Peak Repetitive Reverse Voltage | V_{RRM} | | 600 | V |
| Continuous (direct) forward current | I_F | $T_j=T_{jmax}$ $T_h=80^{\circ}C$ | 17 | A |
| Repetitive peak forward current | I_{FRM} | | 20 | A |
| Total power dissipation | P_{tot} | $T_j=T_{jmax}$ $T_h=80^{\circ}C$ | 34 | W |
| Maximum Junction Temperature | T_{jmax} | | 175 | $^{\circ}C$ |



| Parameter | Symbol | Conditions | Value | Unit |
|--|------------|---|-------|------------------|
| Rectifier Diode | | | | |
| Repetitive peak reverse voltage | V_{RRM} | | 1600 | V |
| Mean forward current | I_{FAV} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 33 | A |
| Surge (non-repetitive) forward current | I_{FSM} | 50 Hz Single Half Sine Wave | 200 | A |
| Surge current capability | I^2t | $t_p = 10\text{ ms}$ 50 Hz sine $T_j = 150\text{ °C}$ | 200 | A ² s |
| Total power dissipation | P_{tot} | $T_j = T_{jmax}$ $T_s = 80\text{ °C}$ | 43 | W |
| Maximum Junction Temperature | T_{jmax} | | 150 | °C |

| Parameter | Symbol | Conditions | Value | Unit |
|--------------------------------|-----------|------------|----------------------------|------|
| Module Properties | | | | |
| Thermal Properties | | | | |
| Storage temperature | T_{stg} | | -40...+125 | °C |
| Operation Junction Temperature | T_{jop} | | -40...+($T_{jmax} - 25$) | °C |

| Isolation Properties | | | | | |
|-----------------------------|------------|------------|----------|-----------|----|
| Isolation voltage | V_{isol} | DC voltage | $t_p=2s$ | 4000 | V |
| Creepage distance | | | | min 12,7 | mm |
| Clearance | | | | min 11,84 | mm |
| Comparative Tracking Index | CTI | | | >200 | |



Characteristic Values

Inverter Switch

| Parameter | Symbol | Conditions | | | | Value | | | Unit |
|-----------|--------|--------------|--------------|-----------|------------|-------|-----|-----|------|
| | | V_{CE} [V] | V_{CE} [V] | I_C [A] | T_j [°C] | Min | Typ | Max | |

Static

| | | | | | | | | | | |
|--------------------------------------|--------------|-----------------|----|-----|---------|------------------|-----|-----------|-----|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE}=V_{CE}$ | | | 0,00029 | 25 125 | 5 | 5,8 | 6,5 | V |
| Collector-emitter saturation voltage | V_{CEsat} | | 15 | | 20 | 25 125 150 | 1,1 | 1,52 - | 1,9 | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 600 | | 25 125 | | | 1,1 | μA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 125 | | | 300 | nA |
| Internal gate resistance | r_g | | | | | | | none | | Ω |
| Input capacitance | C_{ies} | | | | | | | 1100 | | pF |
| Output capacitance | C_{oes} | f=1 MHz | 0 | 25 | 25 | | | 71 | | |
| Reverse transfer capacitance | C_{res} | | | | | | | 32 | | |
| Gate charge | Q_g | | 15 | 480 | 20 | 25 | | 120 | | nC |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|--|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Phase-Change Material $\lambda=3,4W/mK$ | | | | | | 1,81 | | K/W |
|-------------------------------------|---------------|--|--|--|--|--|--|------|--|-----|

IGBT Switching

| | | | | | | | | | | |
|-----------------------------|--------------|--|-----|-----|----|-----------|--|----------------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | | | | | 25 150 | | 71 70 | | ns |
| Rise time | t_r | $R_{goff} = 16 \Omega$ $R_{gon} = 16 \Omega$ | | | | 25 150 | | 11 16 | | |
| Turn-off delay time | $t_{d(off)}$ | | ±15 | 300 | 20 | 25 150 | | 122 143 | | |
| Fall time | t_f | | | | | 25 150 | | 91 111 | | |
| Turn-on energy (per pulse) | E_{on} | $Q_{rFWD} = 0,8 \mu C$ $Q_{rFWD} = 1,7 \mu C$ | | | | 25 150 | | 0,259 0,380 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 25 150 | | 0,448 0,613 | | |



Vincotech

Inverter Diode

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|------------|--|-----------|-----------|------------|-------|-----|-----|------|
| | | | | V_r [V] | I_F [A] | T_j [°C] | Min | Typ | Max | |

Static

| | | | | | | | | | | |
|-------------------------|-------|--|--|-----|----|------------------|--|-------------------|---------|---------|
| Forward voltage | V_F | | | | 20 | 25 125 150 | | 1,70 1,58 - | 1,95 | V |
| Reverse leakage current | I_r | | | 600 | | 25 150 | | | 27 - | μ A |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Phase-Change Material $\lambda=3,4W/mK$ | | | | | | 2,37 | | K/W |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|

FWD Switching

| | | | | | | | | | | |
|---------------------------------------|----------------------|--|----------|-------|----|-----------|--|-------|--|---------|
| Peak recovery current | I_{RRM} | $di/dt = 2072 A/\mu s$ $di/dt = 1922 A/\mu s$ | ± 15 | 300 | 20 | 25 | | 22 | | A |
| | | | | | | 150 | | 26 | | |
| Reverse recovery time | t_{rr} | | | | | 25 | | 125 | | ns |
| | | | | | | 150 | | 204 | | |
| Recovered charge | Q_r | | | | | 25 | | 0,809 | | μ C |
| | | 150 | | 1,713 | | | | | | |
| Reverse recovered energy | E_{rec} | 25 | | 0,171 | | mWs | | | | |
| | | 150 | | 0,373 | | | | | | |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | 25 | | 2050 | | $A/\mu s$ | | | | |
| | | 150 | | 741 | | | | | | |



Vincotech

Brake Switch

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|--------------|--------------|-----------|------------|-----|-------|-----|--|------|
| | | V_{GE} [V] | V_{CE} [V] | I_C [A] | T_j [°C] | Min | Typ | Max | | |

Static

| | | | | | | | | | | |
|--------------------------------------|--------------|-----------------|----|-----|---------|------------------|-----|-----------|------|----|
| Gate-emitter threshold voltage | $V_{GE(th)}$ | $V_{CE}=V_{CE}$ | | | 0,00021 | 25 125 | 5 | 5,8 | 6,5 | V |
| Collector-emitter saturation voltage | V_{CEsat} | | 15 | | 15 | 25 125 150 | 1,1 | 1,59 - | 1,9 | V |
| Collector-emitter cut-off current | I_{CES} | | 0 | 600 | | 25 125 | | | 0,85 | µA |
| Gate-emitter leakage current | I_{GES} | | 20 | 0 | | 25 125 | | | 300 | nA |
| Internal gate resistance | r_g | | | | | | | none | | Ω |
| Input capacitance | C_{ies} | | | | | | | 860 | | pF |
| Output capacitance | C_{oes} | f=1 MHz | 0 | 25 | 25 | | | 55 | | |
| Reverse transfer capacitance | C_{res} | | | | | | | 24 | | |
| Gate charge | Q_g | | 15 | 480 | 15 | 25 | | 87 | | nC |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|--|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Phase-Change Material $\lambda=3,4W/mK$ | | | | | | 2,03 | | K/W |
|-------------------------------------|---------------|--|--|--|--|--|--|------|--|-----|

IGBT Switching

| | | | | | | | | | | |
|-----------------------------|--------------|---|------|-----|----|-----|--|-------|--|-----|
| Turn-on delay time | $t_{d(on)}$ | $R_{goff} = 16 \Omega$ $R_{gon} = 32 \Omega$ | 15/0 | 300 | 15 | 25 | | 19 | | ns |
| Rise time | t_r | | | | | 125 | | 21 | | |
| Turn-off delay time | $t_{d(off)}$ | | | | | 25 | | 186 | | |
| Fall time | t_f | | | | | 125 | | 202 | | |
| Turn-on energy (per pulse) | E_{on} | $Q_{rFWD} = 0,5 \mu C$ $Q_{rFWD} = 0 \mu C$ | | | | 25 | | 0,334 | | mWs |
| Turn-off energy (per pulse) | E_{off} | | | | | 125 | | 0,408 | | |
| | | | | | | 25 | | 0,318 | | |
| | | | | | | 125 | | 0,402 | | |



Vincotech

Brake Diode

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|------------|--|-----------|-----------|------------|-------|-----|-----|------|
| | | | | V_r [V] | I_F [A] | T_j [°C] | Min | Typ | Max | |

Static

| | | | | | | | | | | |
|-------------------------|-------|--|--|-----|----|-----------|--|--------------|---------|---------|
| Forward voltage | V_F | | | | 10 | 25 150 | | 1,60 1,56 | 1,95 | V |
| Reverse leakage current | I_r | | | 600 | | 25 150 | | | 27 - | μ A |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to sink | $R_{th(j-s)}$ | Phase-Change Material $\lambda=3,4\text{W/mK}$ | | | | | | 2,79 | | K/W |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|

FWD Switching

| | | | | | | | | | | |
|---------------------------------------|----------------------|--|------|-------|----|------------------------|--|-------|--|---------|
| Peak recovery current | I_{RRM} | $di/dt = 670\text{ A}/\mu\text{s}$ $di/dt = 0\text{ A}/\mu\text{s}$ | 15/0 | 300 | 15 | 25 | | 8 | | A |
| Reverse recovery time | t_{rr} | | | | | 125 | | 9 | | ns |
| | | | | | | 25 | | 198 | | |
| Recovered charge | Q_r | | | | | 125 | | 0,514 | | μ C |
| | | | | | | 25 | | 0,935 | | |
| Reverse recovered energy | E_{rec} | 25 | | 0,094 | | mWs | | | | |
| | | 125 | | 0,187 | | | | | | |
| Peak rate of fall of recovery current | $(di_{rr}/dt)_{max}$ | 25 | | 411 | | $\text{A}/\mu\text{s}$ | | | | |
| | | 125 | | 78 | | | | | | |



Vincotech

Rectifier Diode

| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|------------|--|-----------|-----------|-------|-------|-----|-----|------|
| | | | | V_r [V] | I_F [A] | T_j | Min | Typ | Max | |

Static

| | | | | | | | | | | |
|-------------------------|-------|--|--|------|----|------------------------|--|-------------------|------------|----|
| Forward voltage | V_F | | | | 25 | 25°C 125°C 150°C | | 1,22 1,21 - | 1,9 | V |
| Reverse leakage current | I_R | | | 1600 | | 25°C 150°C | | | 50 1100 | μA |

Thermal

| | | | | | | | | | | |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|
| Thermal resistance junction to case | $R_{th(j-c)}$ | Phase-Change Material $\lambda=3,4W/mK$ | | | | | | 1,61 | | K/W |
|-------------------------------------|---------------|---|--|--|--|--|--|------|--|-----|

Thermistor

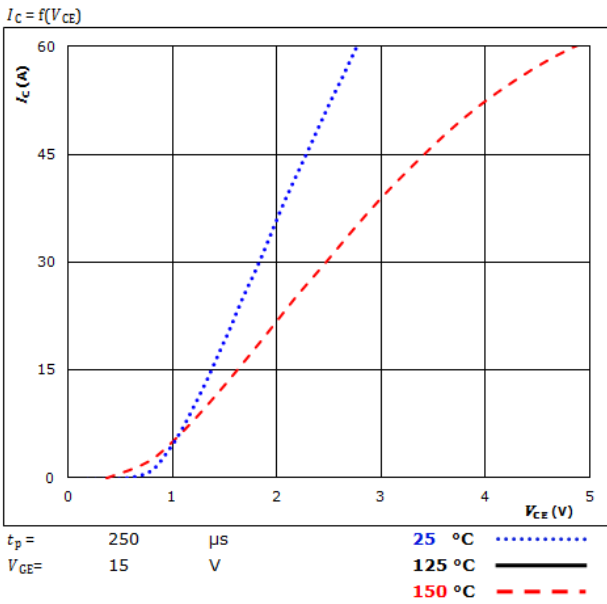
| Parameter | Symbol | Conditions | | | | | Value | | | Unit |
|-----------|--------|------------|--------------|--------------|-----------|------------|-------|-----|-----|------|
| | | | V_{GE} [V] | V_{CE} [V] | I_C [A] | T_j [°C] | Min | Typ | Max | |

| | | | | | | | | | | |
|----------------------------|----------------|-------------|--|--|--|-----|-----|------|-----|------|
| Rated resistance | R | | | | | 25 | | 22 | | kΩ |
| Deviation of R100 | $\Delta_{R/R}$ | R100=1486 Ω | | | | 100 | -12 | | +12 | % |
| Power dissipation | P | | | | | 25 | | 200 | | mW |
| Power dissipation constant | | | | | | 25 | | 2 | | mW/K |
| B-value | $B_{(25/50)}$ | Tol. ±3% | | | | 25 | | 3950 | | K |
| B-value | $B_{(25/100)}$ | Tol. ±3% | | | | 25 | | 3998 | | K |
| Vincotech NTC Reference | | | | | | | | | B | |

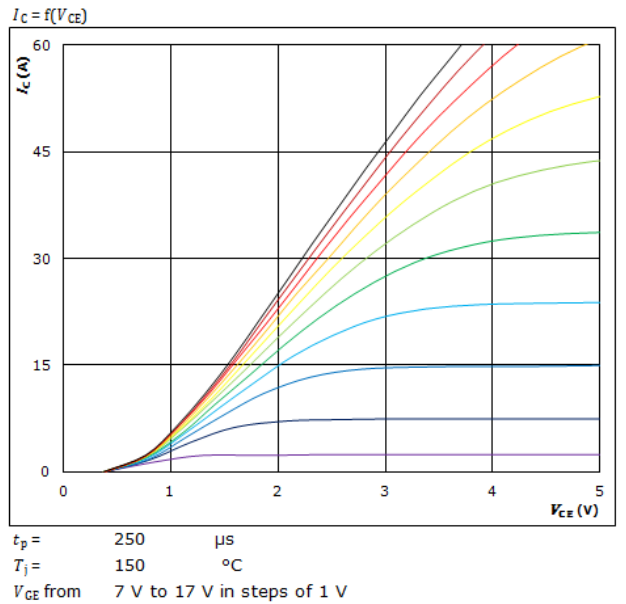


Inverter Switch Characteristics

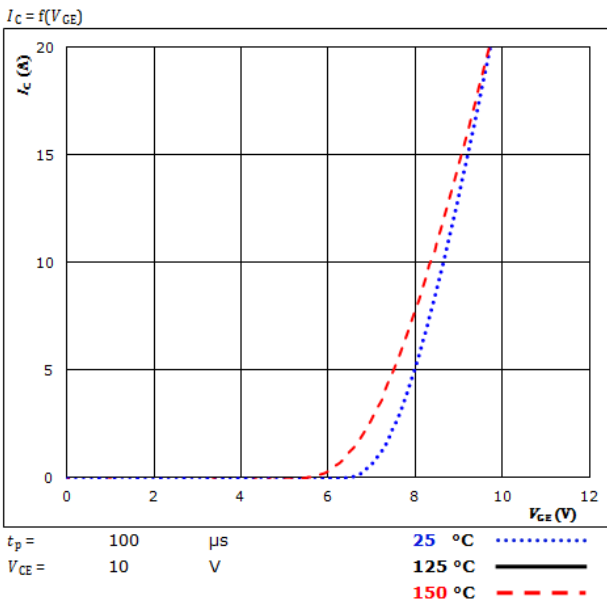
Typical output characteristics IGBT



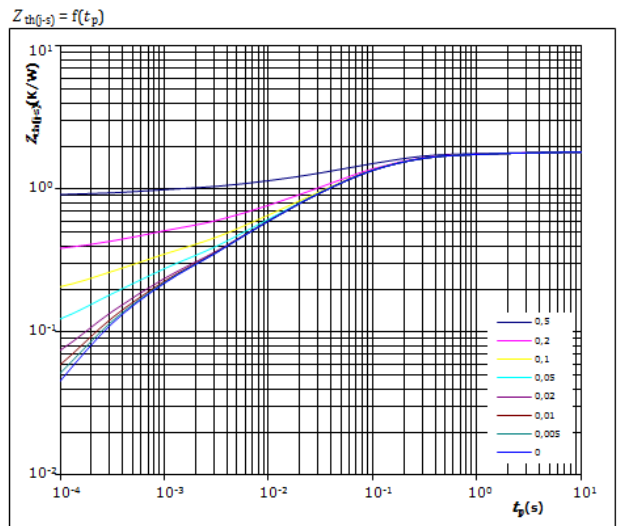
Typical output characteristics IGBT



Typical transfer characteristics IGBT



Transient Thermal Impedance as function of Pulse duration IGBT



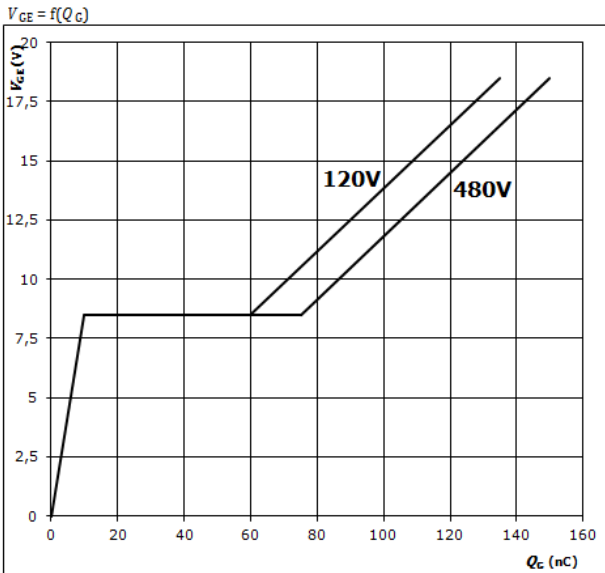
IGBT thermal model values

| R_{th} (K/W) | τ (s) |
|----------------|------------|
| 6,63E-02 | 3,68E+00 |
| 1,83E-01 | 4,61E-01 |
| 8,24E-01 | 8,38E-02 |
| 3,93E-01 | 1,82E-02 |
| 1,96E-01 | 3,57E-03 |
| 1,49E-01 | 3,52E-04 |



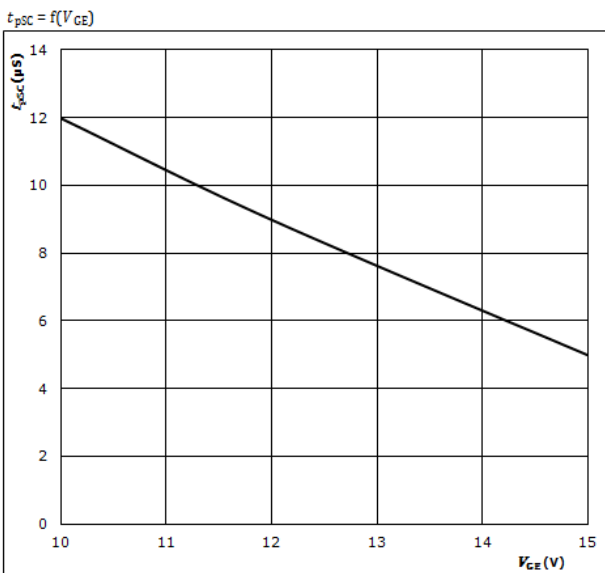
Inverter Switch Characteristics

Gate voltage vs Gate charge IGBT



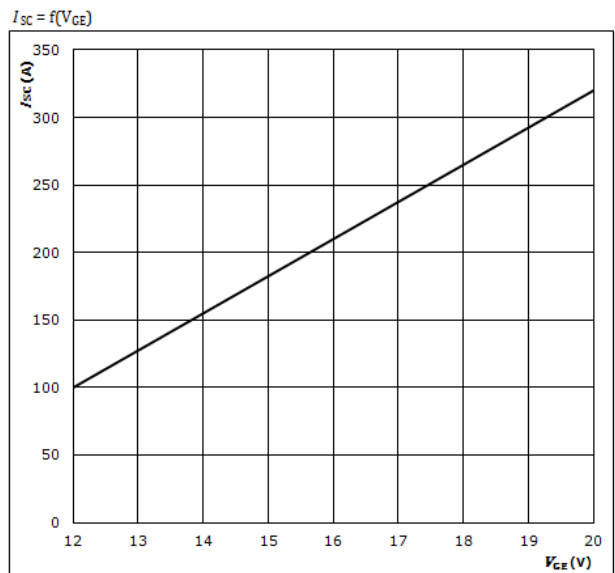
At
 $I_C = 20$ A

Short circuit duration as a function of V_{CE} IGBT



At
 $V_{CE} = 600$ V
 $T_j \leq 175$ °C

Typical short circuit current as a function of V_{CE} IGBT

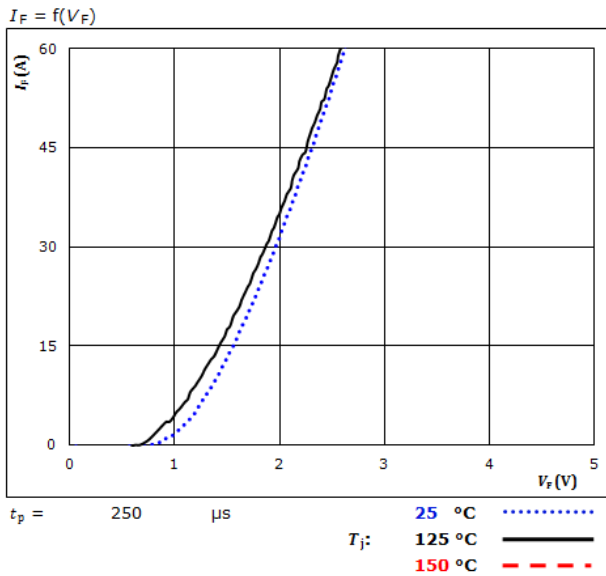


At
 $V_{CE} \leq 600$ V
 $T_j \leq 175$ °C

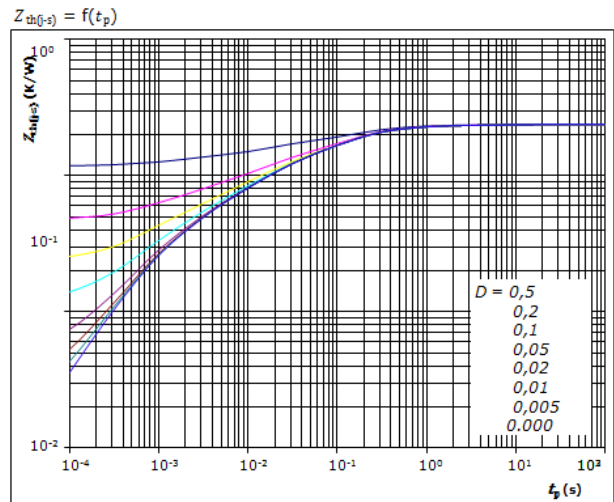


Inverter Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



$D = t_p / T$
 $R_{th(j-s)} = 2,37 \text{ K/W}$

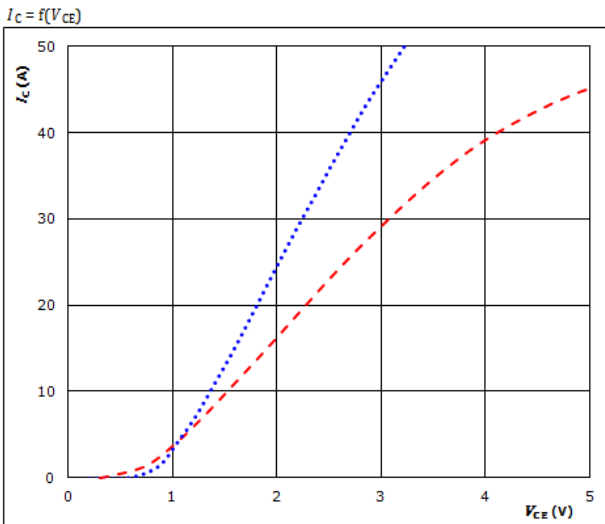
FWD thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 4,62E-02 | 8,95E+00 |
| 1,39E-01 | 1,10E+00 |
| 6,93E-01 | 1,96E-01 |
| 5,75E-01 | 6,44E-02 |
| 6,19E-01 | 9,95E-03 |
| 2,95E-01 | 1,01E-03 |



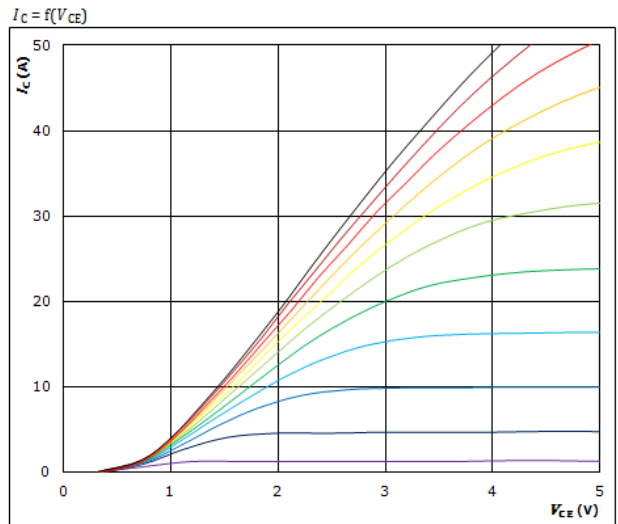
Brake Switch Characteristics

Typical output characteristics IGBT



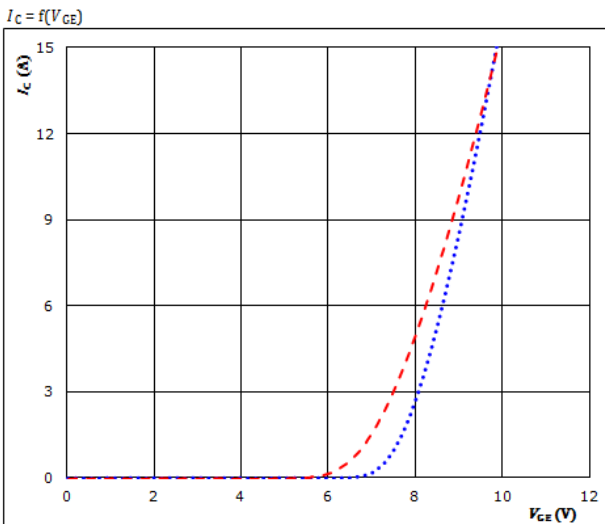
$t_p = 250 \mu s$
 $V_{CE} = 15 V$
 25 °C
 125 °C ———
 150 °C - - - -

Typical output characteristics IGBT



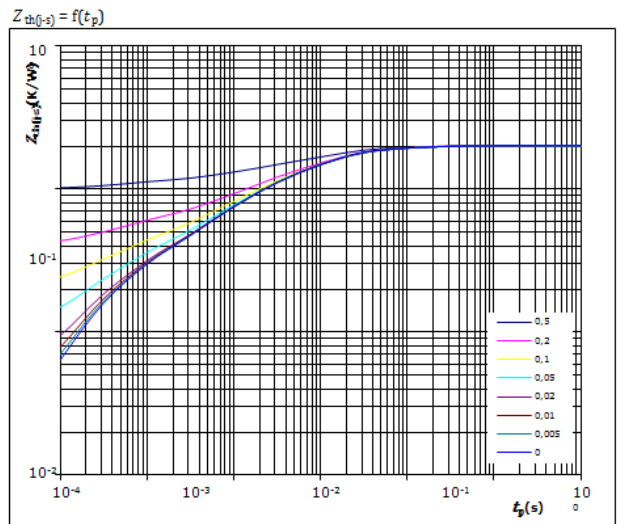
$t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{CE} from 7 V to 17 V in steps of 1 V

Typical transfer characteristics IGBT



$t_p = 100 \mu s$
 $V_{CE} = 10 V$
 25 °C
 125 °C ———
 150 °C - - - -

Transient Thermal Impedance as function of Pulse duration IGBT



$D = t_p / T$
 $R_{th(j-s)} = 2,03 K/W$

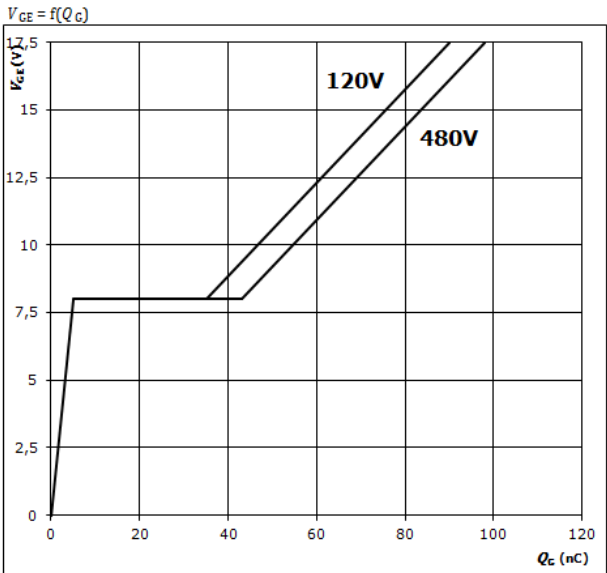
IGBT thermal model values

| R_{th} (K/W) | τ (s) |
|----------------|------------|
| 3,94E-02 | 6,65E+00 |
| 2,08E-01 | 7,06E-01 |
| 7,57E-01 | 1,14E-01 |
| 5,53E-01 | 1,86E-02 |
| 2,62E-01 | 3,35E-03 |
| 2,07E-01 | 3,46E-04 |



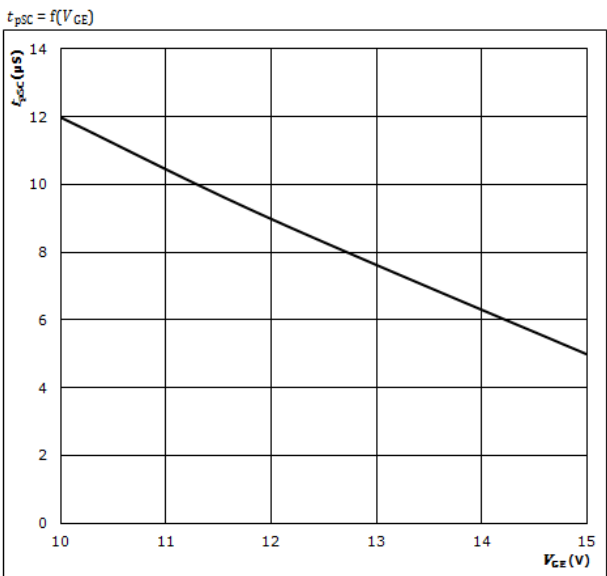
Brake Switch Characteristics

Gate voltage vs Gate charge IGBT



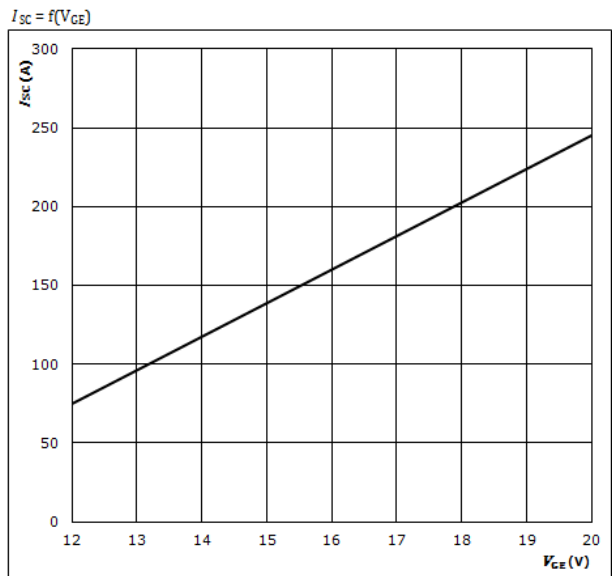
At
 $I_C = 15$ A

Short circuit duration as a function of V_{CE} IGBT



At
 $V_{CE} = 600$ V
 $T_j \leq 175$ °C

Typical short circuit current as a function of V_{CE} IGBT

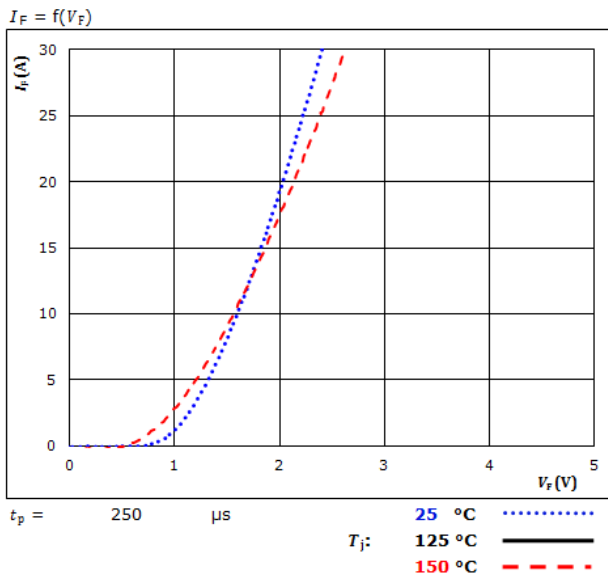


At
 $V_{CE} \leq 600$ V
 $T_j \leq 175$ °C

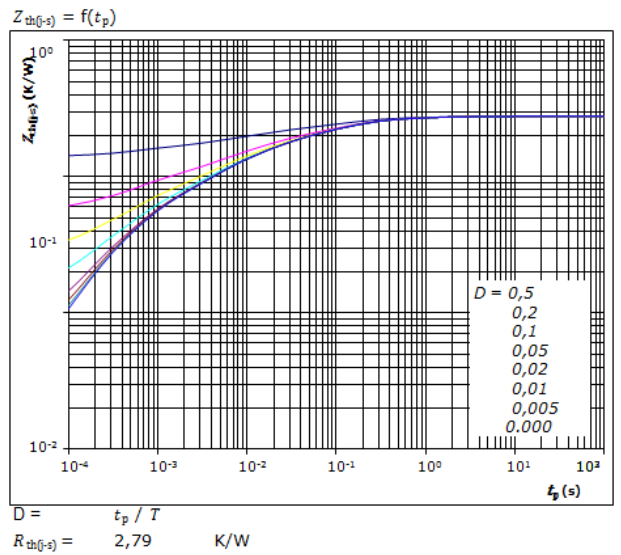


Brake Diode Characteristics

Typical forward characteristics FWD



Transient thermal impedance as a function of pulse width FWD



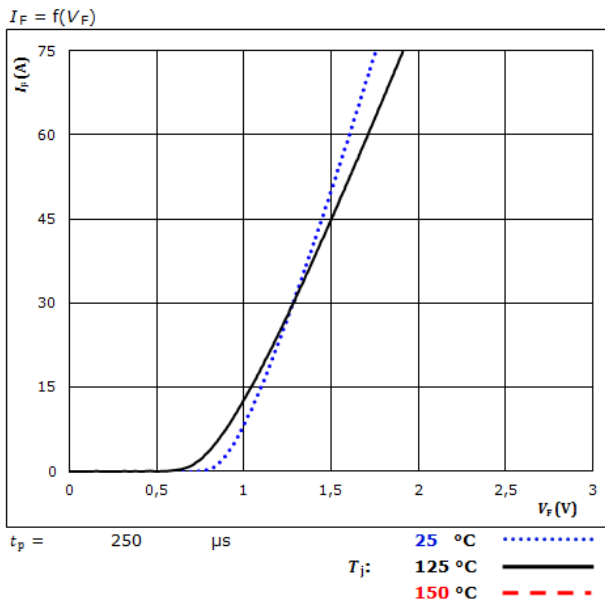
FWD thermal model values

| R (K/W) | τ (s) |
|----------|------------|
| 3,61E-02 | 8,54E+00 |
| 2,58E-01 | 5,80E-01 |
| 8,01E-01 | 1,03E-01 |
| 7,36E-01 | 1,63E-02 |
| 5,56E-01 | 3,27E-03 |
| 3,99E-01 | 4,24E-04 |

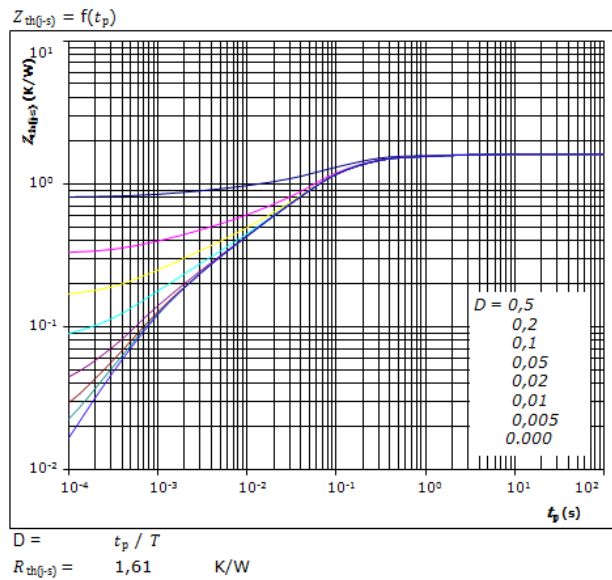


Rectifier Diode Characteristics

Typical forward characteristics Rectifier Diode



Transient thermal impedance as a function of pulse width Rectifier Diode



Diode thermal model values

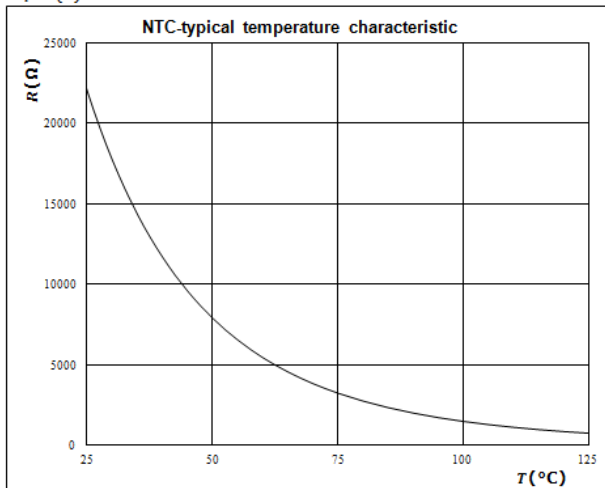
| R (K/W) | τ (s) |
|----------|------------|
| 6,72E-02 | 2,72E+00 |
| 1,48E-01 | 4,14E-01 |
| 8,68E-01 | 8,33E-02 |
| 2,53E-01 | 2,89E-02 |
| 1,69E-01 | 5,15E-03 |
| 1,06E-01 | 9,10E-04 |

Thermistor Characteristics

Thermistor typical temperature characteristic

Typical NTC characteristic
as a function of temperature

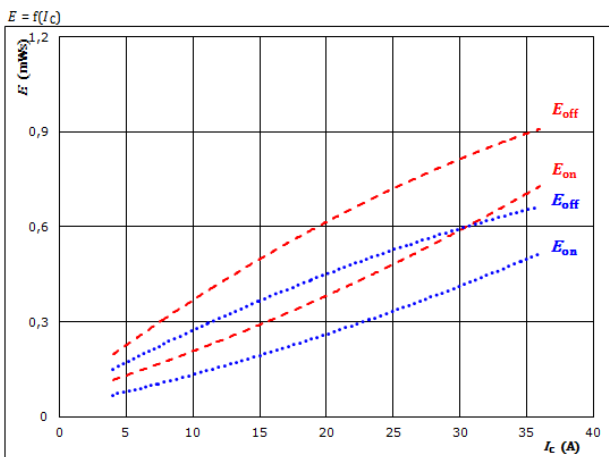
$R_T = f(T)$





Inverter Switching Characteristics

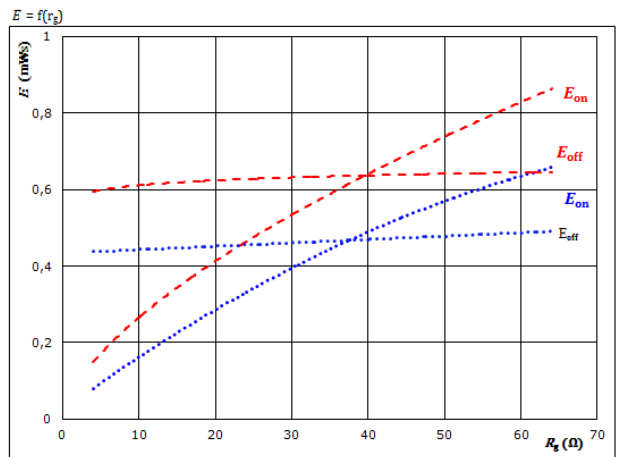
Figure 1. IGBT
Typical switching energy losses as a function of collector current



With an inductive load at

| | | |
|---------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = \pm 15$ V | 125 °C | ———— |
| $R_{gon} = 16$ Ω | 150 °C | ----- |
| $R_{goff} = 16$ Ω | | |

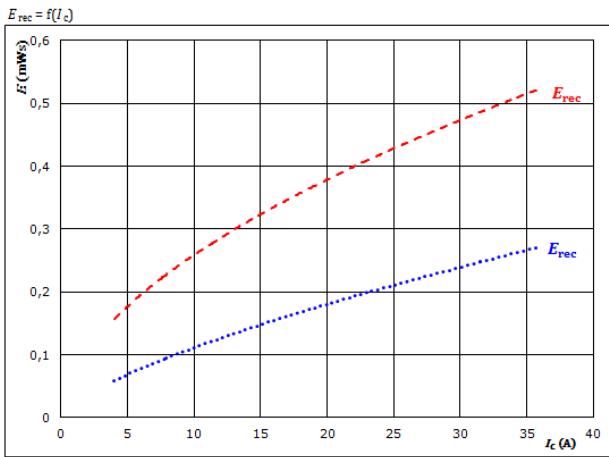
Figure 2. IGBT
Typical switching energy losses as a function of gate resistor



With an inductive load at

| | | |
|---------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = \pm 15$ V | 125 °C | ———— |
| $I_C = 20$ A | 150 °C | ----- |

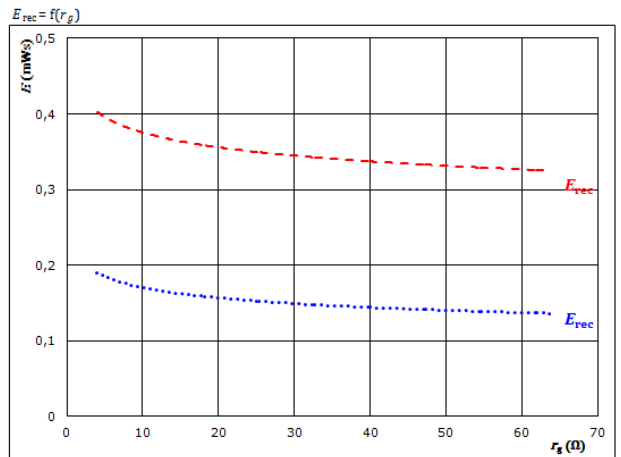
Figure 3. FWD
Typical reverse recovered energy loss as a function of collector current



With an inductive load at

| | | |
|---------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = \pm 15$ V | 125 °C | ———— |
| $R_{gon} = 16$ Ω | 150 °C | ----- |

Figure 4. FWD
Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at

| | | |
|---------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = \pm 15$ V | 125 °C | ———— |
| $I_C = 20$ A | 150 °C | ----- |

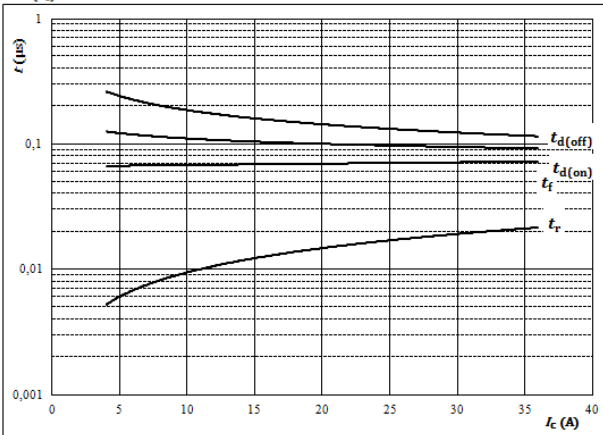


Inverter Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



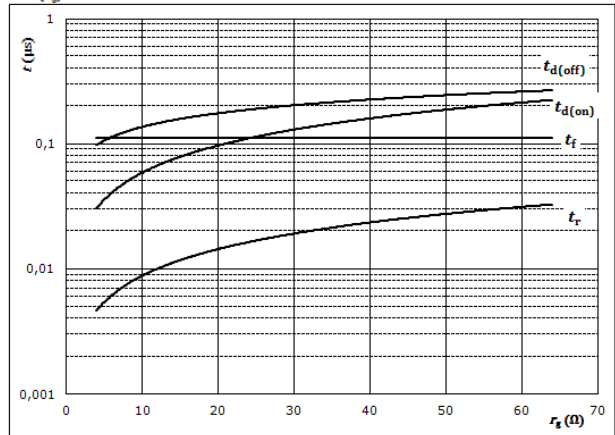
With an inductive load at

| | | |
|--------------|-----|----|
| $T_j =$ | 150 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | ±15 | V |
| $R_{gon} =$ | 16 | Ω |
| $R_{goff} =$ | 16 | Ω |

Figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



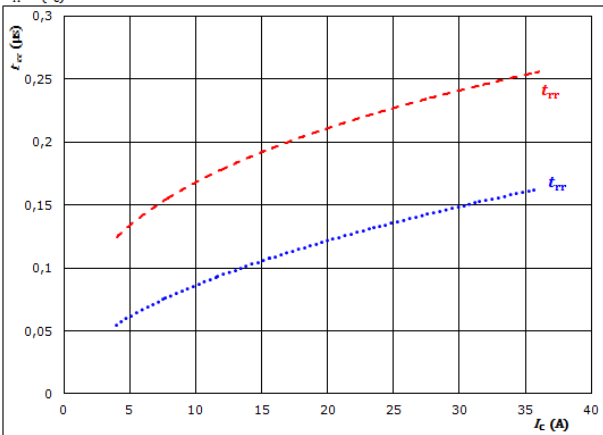
With an inductive load at

| | | |
|------------|-----|----|
| $T_j =$ | 150 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | ±15 | V |
| $I_C =$ | 20 | A |

Figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

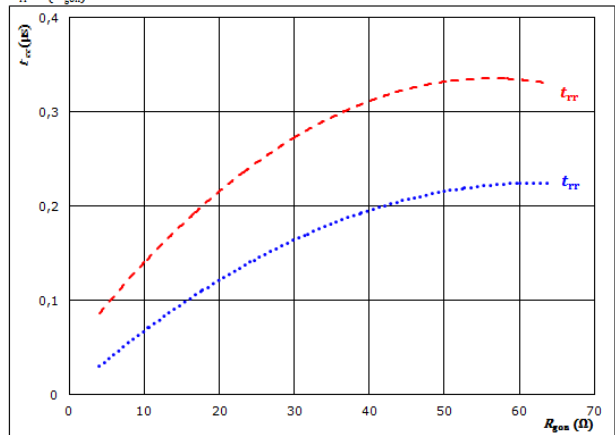


| | | | | | | |
|----|-------------|-----|---|--------|--------|-------|
| At | $V_{CE} =$ | 300 | V | $T_j:$ | 25 °C | |
| | $V_{GE} =$ | ±15 | V | | 125 °C | ———— |
| | $R_{gon} =$ | 16 | Ω | | 150 °C | ----- |

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$

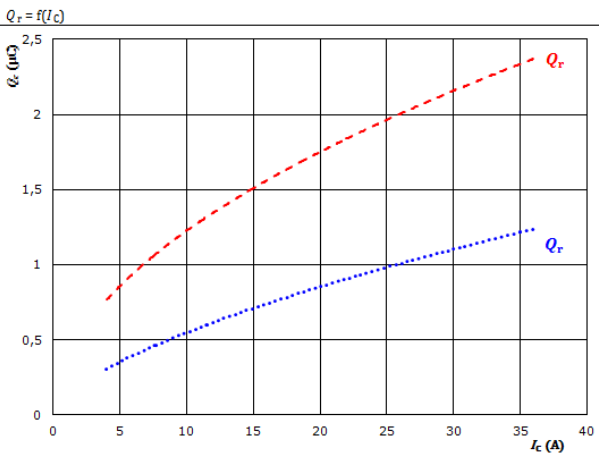


| | | | | | | |
|----|------------|-----|---|--------|--------|-------|
| At | $V_{CE} =$ | 300 | V | $T_j:$ | 25 °C | |
| | $V_{GE} =$ | ±15 | V | | 125 °C | ———— |
| | $I_C =$ | 20 | A | | 150 °C | ----- |



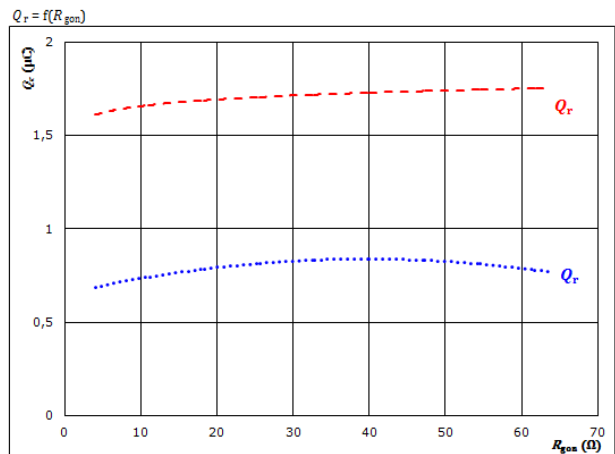
Inverter Switching Characteristics

Figure 9. FWD
Typical recovered charge as a function of collector current



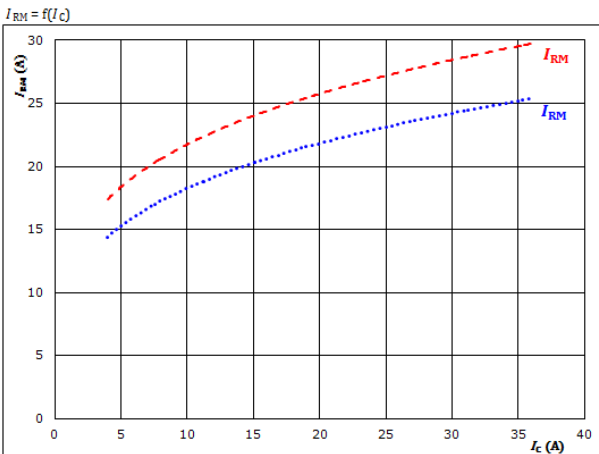
At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 10. FWD
Typical recovered charge as a function of IGBT turn on gate resistor



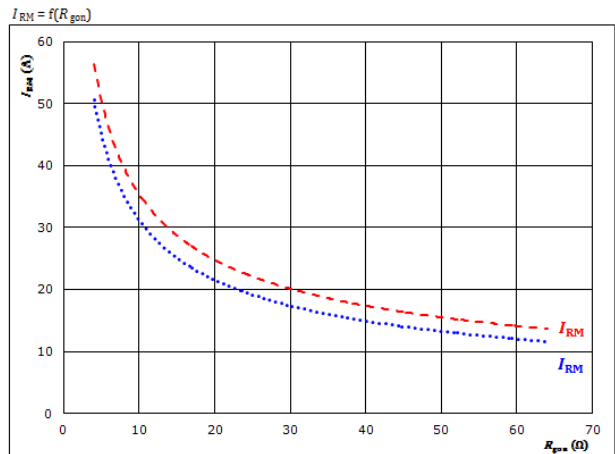
At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 20$ A
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 11. FWD
Typical peak reverse recovery current as a function of collector current



At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)

Figure 12. FWD
Typical peak reverse recovery current as a function of IGBT turn on gate resistor



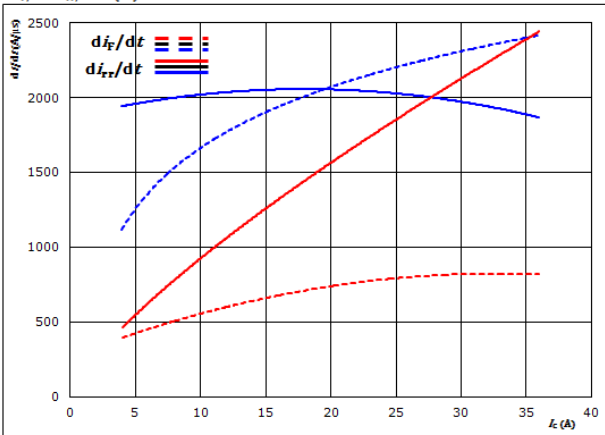
At $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $I_c = 20$ A
 T_j : 25 °C (dotted), 125 °C (solid), 150 °C (dashed)



Inverter Switching Characteristics

Figure 13. FWD

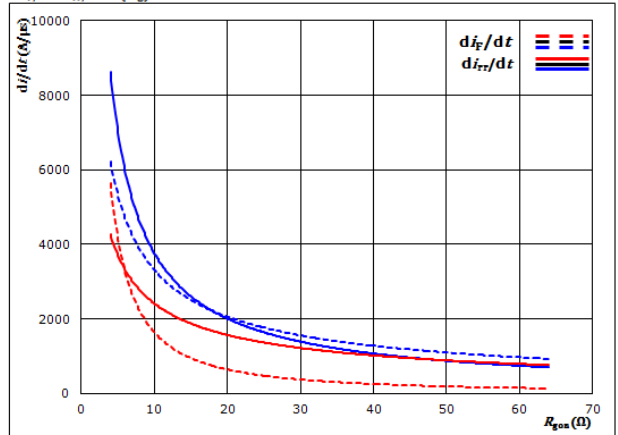
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_C)$



At $V_{CE} = 300$ V
 $V_{CE} = \pm 15$ V
 $R_{gon} = 16$ Ω
 $T_j = 25$ °C
 125 °C
 150 °C

Figure 14. FWD

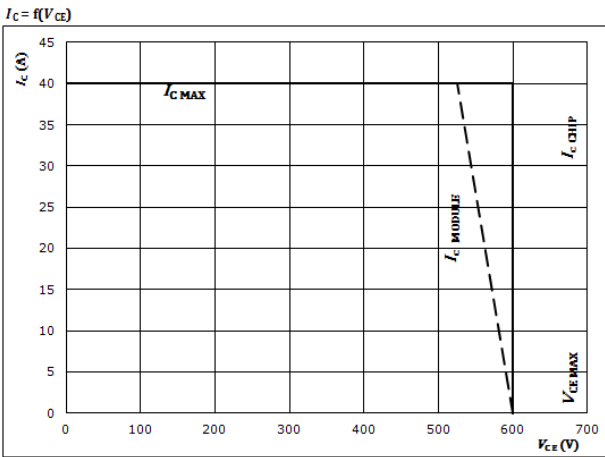
Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_g)$



At $V_{CE} = 300$ V
 $V_{CE} = \pm 15$ V
 $I_C = 20$ A
 $T_j = 25$ °C
 125 °C
 150 °C

Figure 15. IGBT

Reverse bias safe operating area



At $T_j = 175$ °C
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω



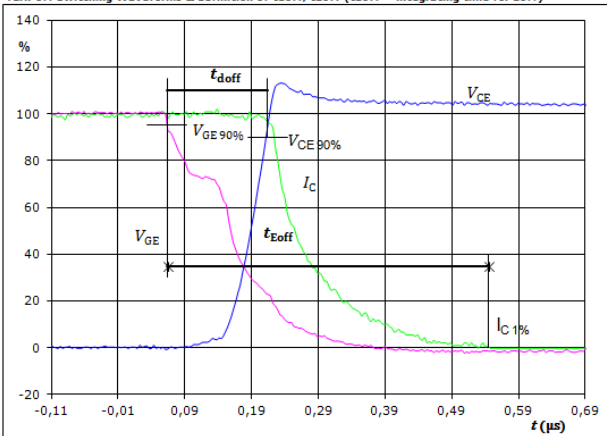
Inverter Switching Characteristics

General conditions

| | | |
|-------------------|---|-------------|
| T_j | = | 150 °C |
| R_{gon} | = | 16 Ω |
| R_{goff} | = | 16 Ω |

Figure 1. IGBT

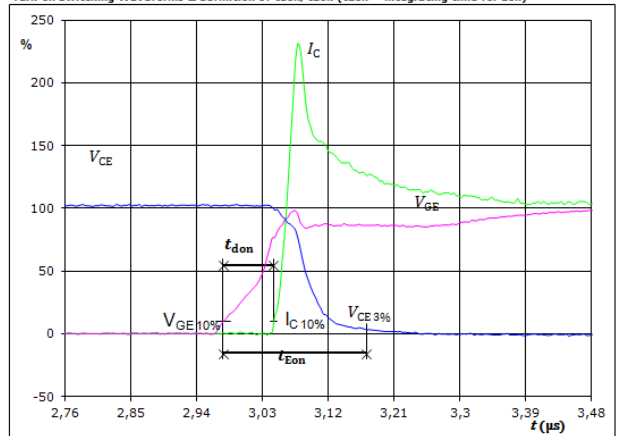
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for Eoff)



| | | |
|--------------------------|-------|---------------|
| $V_{\text{CE}}(0\%) =$ | -15 | V |
| $V_{\text{CE}}(100\%) =$ | 15 | V |
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 20 | A |
| $t_{\text{doff}} =$ | 0,143 | μs |
| $t_{\text{Eoff}} =$ | 0,482 | μs |

Figure 2. IGBT

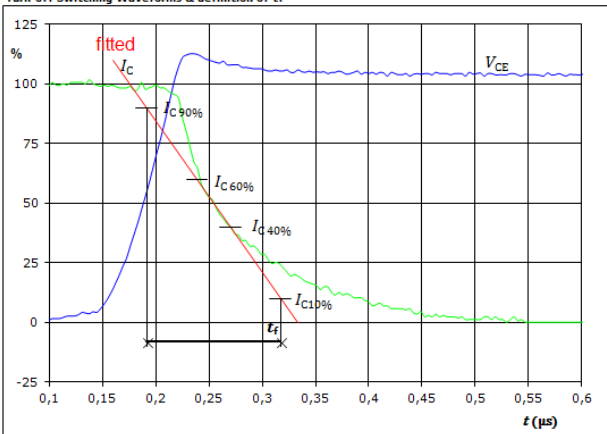
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for Eon)



| | | |
|--------------------------|-------|---------------|
| $V_{\text{CE}}(0\%) =$ | -15 | V |
| $V_{\text{CE}}(100\%) =$ | 15 | V |
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 20 | A |
| $t_{\text{don}} =$ | 0,070 | μs |
| $t_{\text{Eon}} =$ | 0,196 | μs |

Figure 3. IGBT

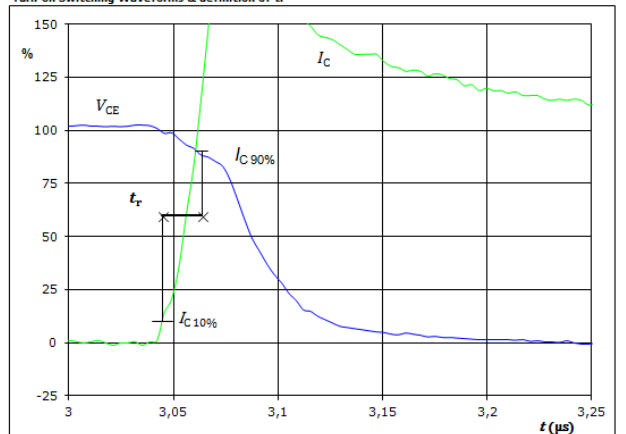
Turn-off Switching Waveforms & definition of t_f



| | | |
|-------------------------|-------|---------------|
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 20 | A |
| $t_f =$ | 0,110 | μs |

Figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

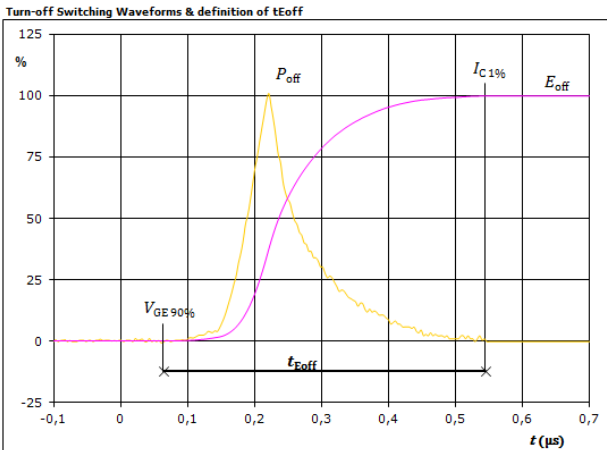


| | | |
|-------------------------|-------|---------------|
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 20 | A |
| $t_r =$ | 0,016 | μs |



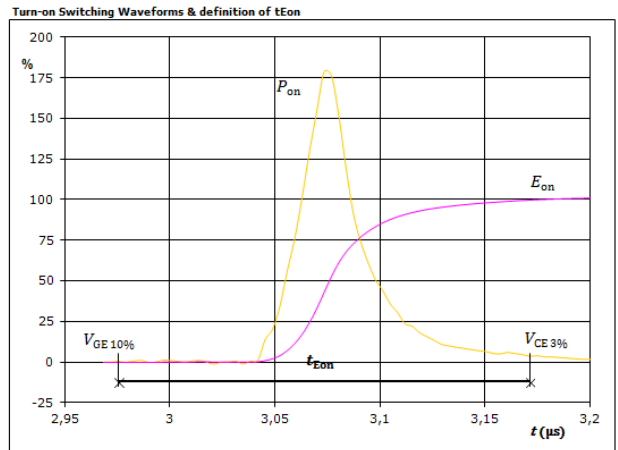
Inverter Switching Characteristics

Figure 5. IGBT



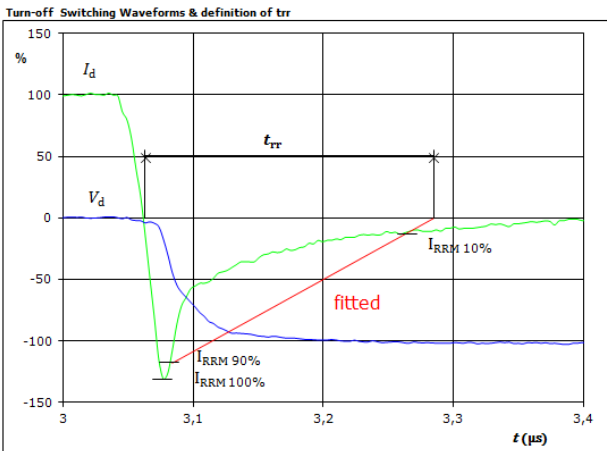
| | | |
|--------------------|------|---------|
| $P_{off}(100\%) =$ | 5,98 | kW |
| $E_{off}(100\%) =$ | 0,61 | mJ |
| $t_{Eoff} =$ | 0,48 | μs |

Figure 6. IGBT



| | | |
|-------------------|------|---------|
| $P_{on}(100\%) =$ | 5,98 | kW |
| $E_{on}(100\%) =$ | 0,38 | mJ |
| $t_{Eon} =$ | 0,20 | μs |

Figure 7. FWD

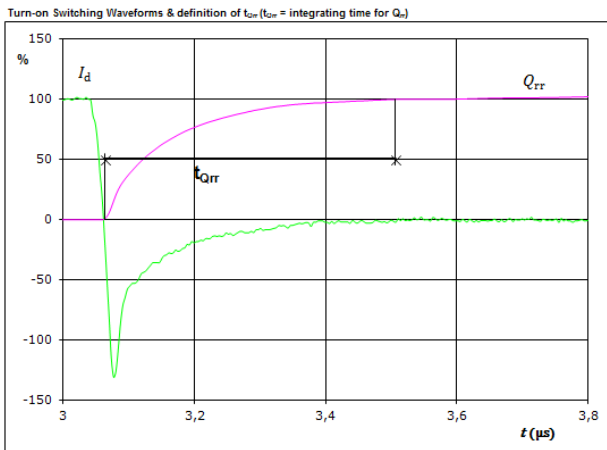


| | | |
|--------------------|-------|---------|
| $V_d(100\%) =$ | 300 | V |
| $I_d(100\%) =$ | 20 | A |
| $I_{RRM}(100\%) =$ | -26 | A |
| $t_{rr} =$ | 0,204 | μs |



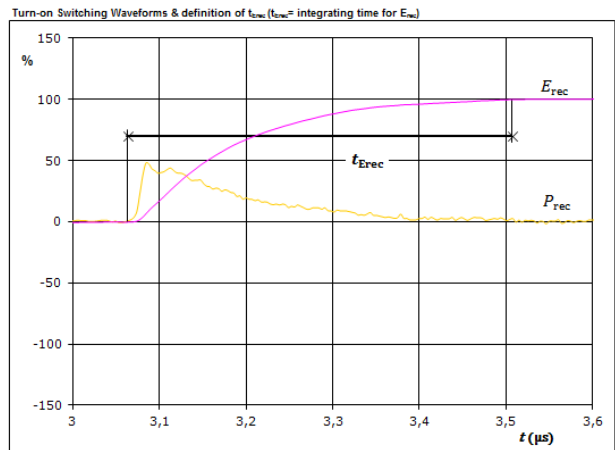
Inverter Switching Characteristics

Figure 8. FWD



| | | |
|-------------------|------|---------------|
| $I_d(100\%) =$ | 20 | A |
| $Q_{rr}(100\%) =$ | 1,71 | μC |
| $t_{Qrr} =$ | 0,44 | μs |

Figure 9. FWD

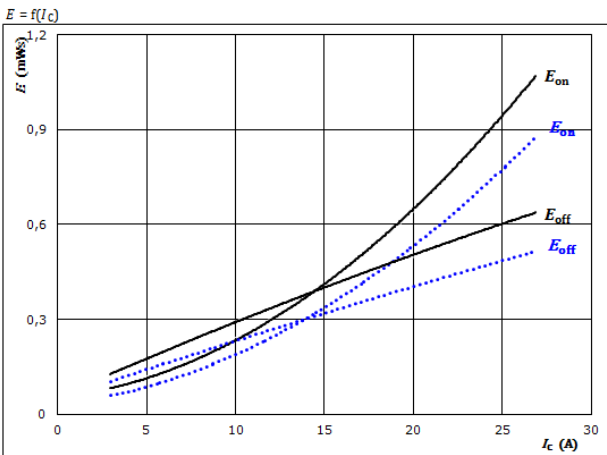


| | | |
|--------------------|------|---------------|
| $P_{rec}(100\%) =$ | 5,98 | kW |
| $E_{rec}(100\%) =$ | 0,37 | mJ |
| $t_{Erec} =$ | 0,44 | μs |



Brake Switching Characteristics

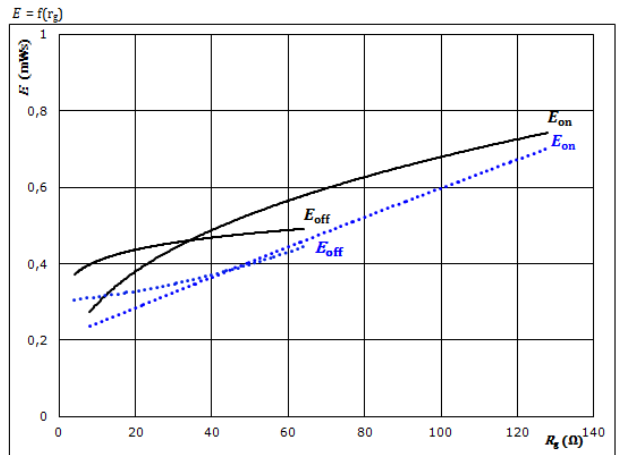
Figure 1. IGBT
Typical switching energy losses as a function of collector current



With an inductive load at

| | | |
|-------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = 15/0$ V | 125 °C | ———— |
| $R_{gon} = 32$ Ω | 150 °C | ----- |
| $R_{goff} = 16$ Ω | | |

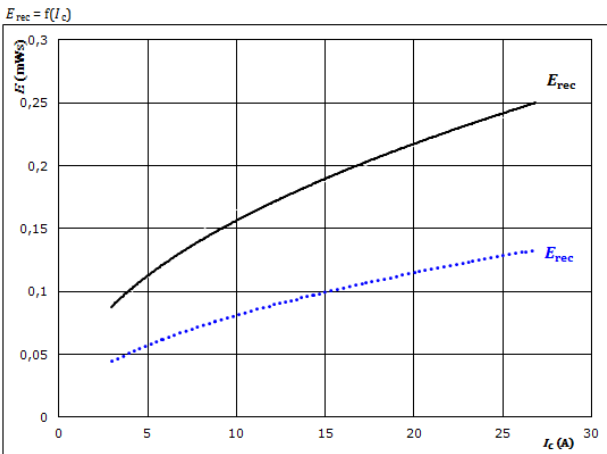
Figure 2. IGBT
Typical switching energy losses as a function of gate resistor



With an inductive load at

| | | |
|-------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = 15/0$ V | 125 °C | ———— |
| $I_C = 15$ A | 150 °C | ----- |

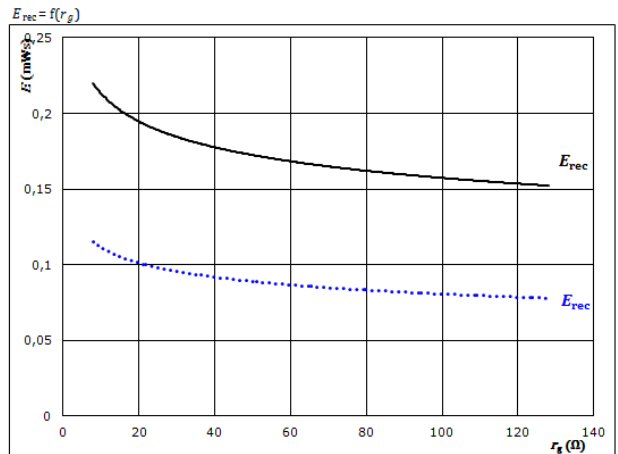
Figure 3. FWD
Typical reverse recovered energy loss as a function of collector current



With an inductive load at

| | | |
|-------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = 15/0$ V | 125 °C | ———— |
| $R_{gon} = 32$ Ω | 150 °C | ----- |

Figure 4. FWD
Typical reverse recovered energy loss as a function of gate resistor



With an inductive load at

| | | |
|-------------------|--------------|-------|
| $V_{CE} = 300$ V | $T_j: 25$ °C | |
| $V_{GE} = 15/0$ V | 125 °C | ———— |
| $I_C = 15$ A | 150 °C | ----- |

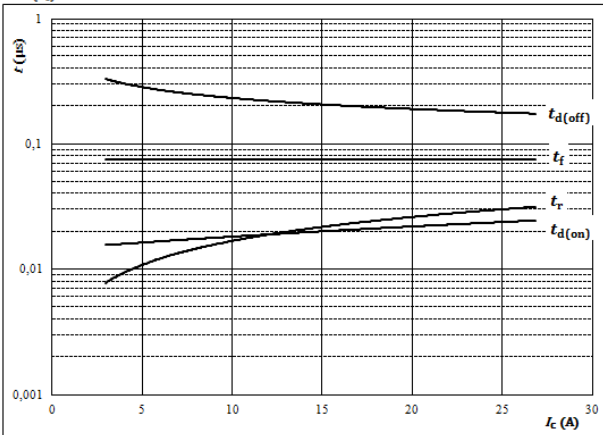


Brake Switching Characteristics

Figure 5. IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



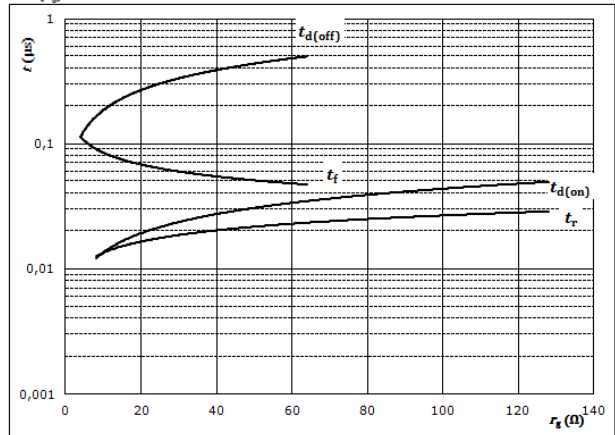
With an inductive load at

| | | |
|--------------|------|----|
| $T_j =$ | 125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15/0 | V |
| $R_{gon} =$ | 32 | Ω |
| $R_{goff} =$ | 16 | Ω |

Figure 6. IGBT

Typical switching times as a function of gate resistor

$$t = f(r_g)$$



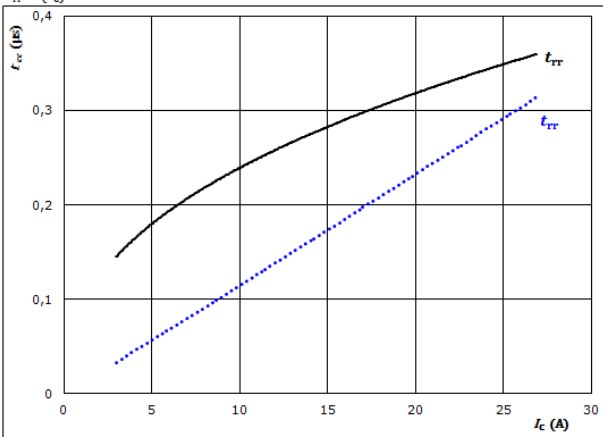
With an inductive load at

| | | |
|------------|------|----|
| $T_j =$ | 125 | °C |
| $V_{CE} =$ | 300 | V |
| $V_{GE} =$ | 15/0 | V |
| $I_C =$ | 15 | A |

Figure 7. FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

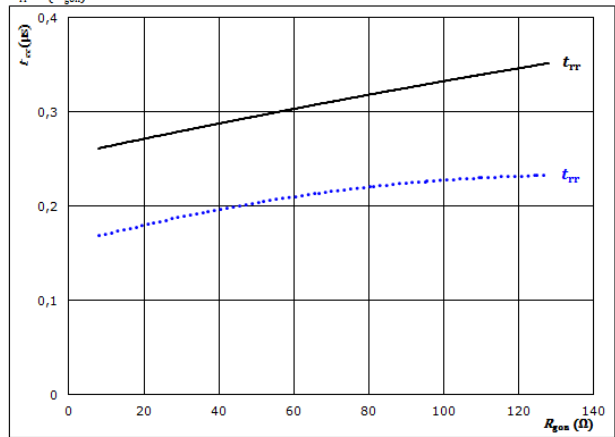


| | | | | | | |
|----|-------------|------|---|--------|--------|-------|
| At | $V_{CE} =$ | 300 | V | $T_j:$ | 25 °C | |
| | $V_{GE} =$ | 15/0 | V | | 125 °C | ———— |
| | $R_{gon} =$ | 32 | Ω | | 150 °C | ----- |

Figure 8. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



| | | | | | | |
|----|------------|------|---|--------|--------|-------|
| At | $V_{CE} =$ | 300 | V | $T_j:$ | 25 °C | |
| | $V_{GE} =$ | 15/0 | V | | 125 °C | ———— |
| | $I_C =$ | 15 | A | | 150 °C | ----- |

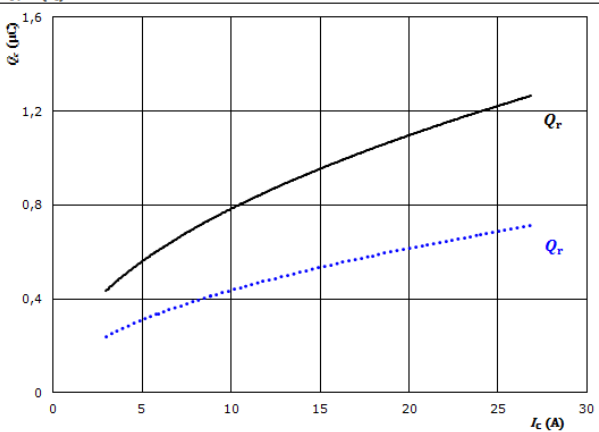


Brake Switching Characteristics

Figure 9. Typical recovered charge as a function of collector current FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

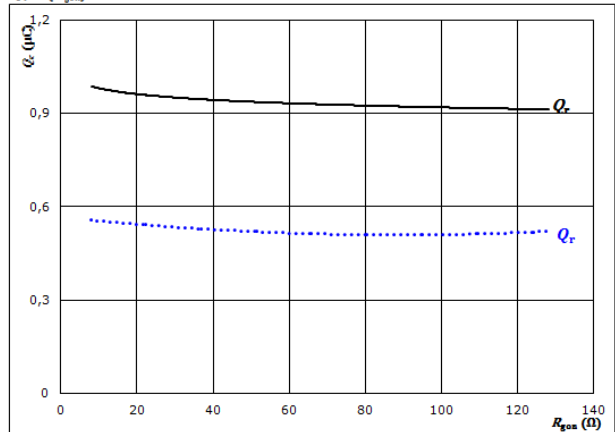


At $V_{CE} = 300$ V
 $V_{GE} = 15/0$ V
 $R_{gon} = 32$ Ω
 T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

Figure 10. Typical recovered charge as a function of IGBT turn on gate resistor FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$

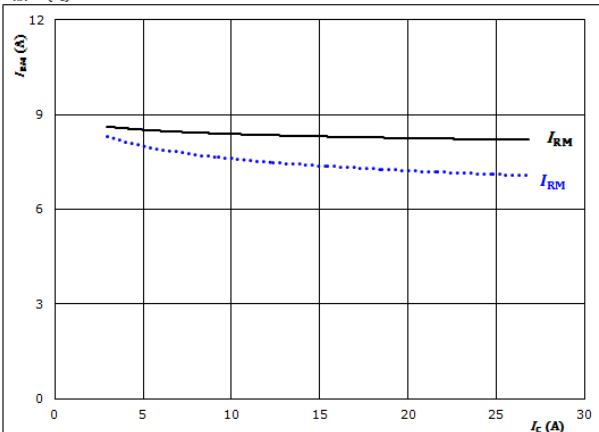


At $V_{CE} = 300$ V
 $V_{GE} = 15/0$ V
 $I_c = 15$ A
 T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

Figure 11. Typical peak reverse recovery current as a function of collector current FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

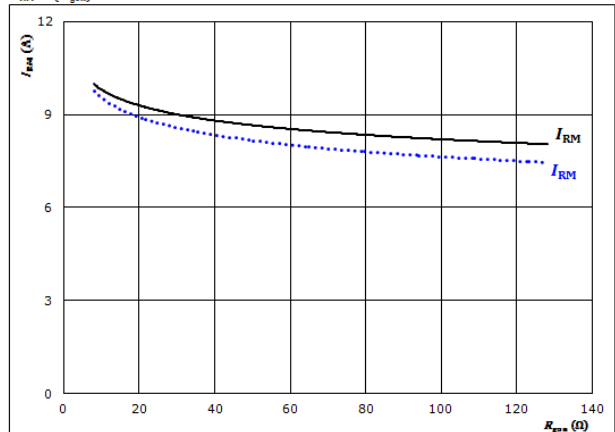


At $V_{CE} = 300$ V
 $V_{GE} = 15/0$ V
 $R_{gon} = 32$ Ω
 T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)

Figure 12. Typical peak reverse recovery current as a function of IGBT turn on gate resistor FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



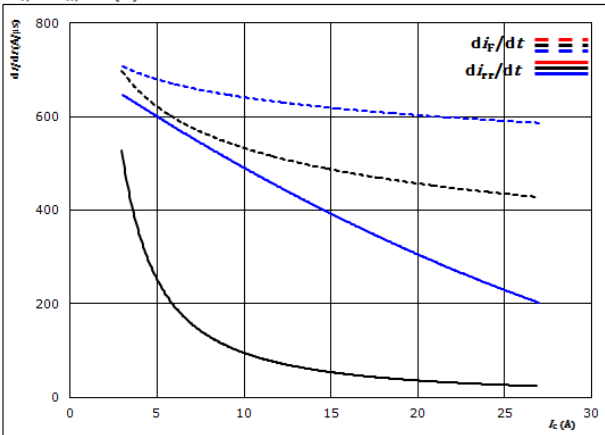
At $V_{CE} = 300$ V
 $V_{GE} = 15/0$ V
 $I_c = 15$ A
 T_j : 25 °C (dotted blue line)
 125 °C (solid black line)
 150 °C (dashed red line)



Brake Switching Characteristics

Figure 13. FWD

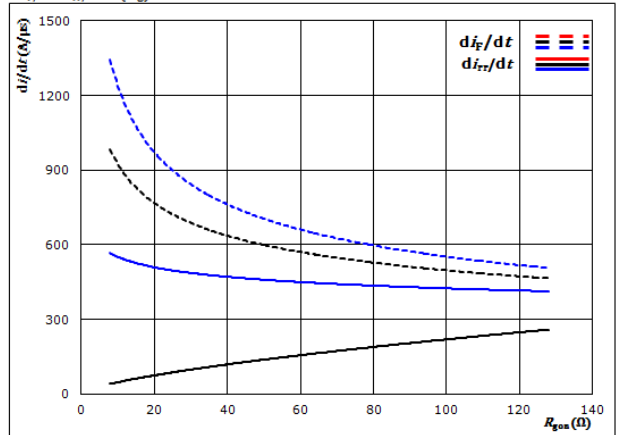
Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_F/dt, di_{rr}/dt = f(I_C)$



At $V_{CE} = 300$ V
 $V_{GE} = 15/0$ V
 $R_{gon} = 32$ Ω
 $T_j = 25$ °C
 125 °C
 150 °C

Figure 14. FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor
 $di_F/dt, di_{rr}/dt = f(R_g)$

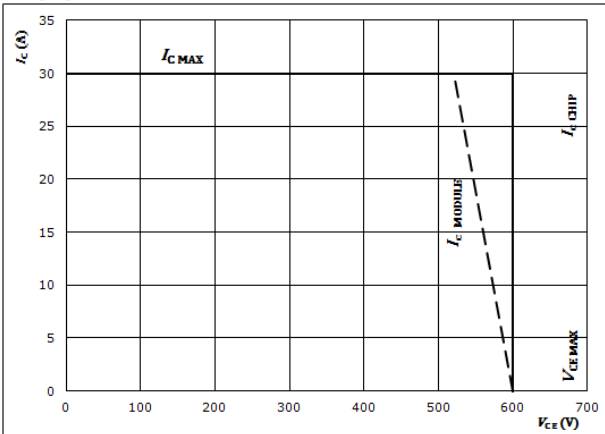


At $V_{CE} = 300$ V
 $V_{GE} = 15/0$ V
 $I_C = 15$ A

Figure 15. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At $T_j = 175$ °C
 $R_{gon} = 32$ Ω
 $R_{goff} = 16$ Ω



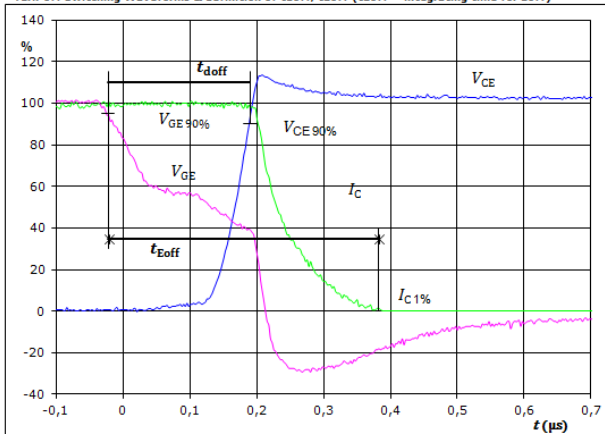
Brake Switching Characteristics

General conditions

| | | |
|-------------------|---|-------------|
| T_j | = | 125 °C |
| R_{gon} | = | 32 Ω |
| R_{goff} | = | 16 Ω |

Figure 1. IGBT

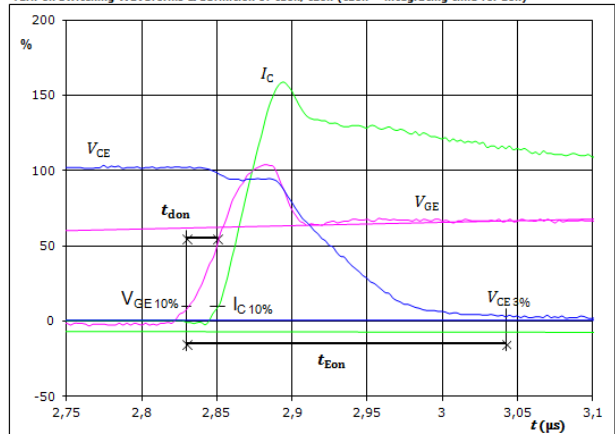
Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for Eoff)



| | | |
|--------------------------|-------|---------------|
| $V_{\text{CE}}(0\%) =$ | 0 | V |
| $V_{\text{CE}}(100\%) =$ | 15 | V |
| $I_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 15 | A |
| $t_{\text{doff}} =$ | 0,203 | μs |
| $t_{\text{Eoff}} =$ | 0,405 | μs |

Figure 2. IGBT

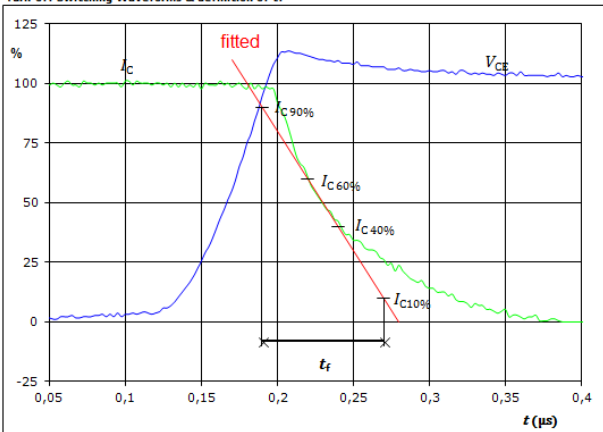
Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for Eon)



| | | |
|--------------------------|-------|---------------|
| $V_{\text{CE}}(0\%) =$ | 0 | V |
| $V_{\text{CE}}(100\%) =$ | 15 | V |
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 15 | A |
| $t_{\text{don}} =$ | 0,020 | μs |
| $t_{\text{Eon}} =$ | 0,213 | μs |

Figure 3. IGBT

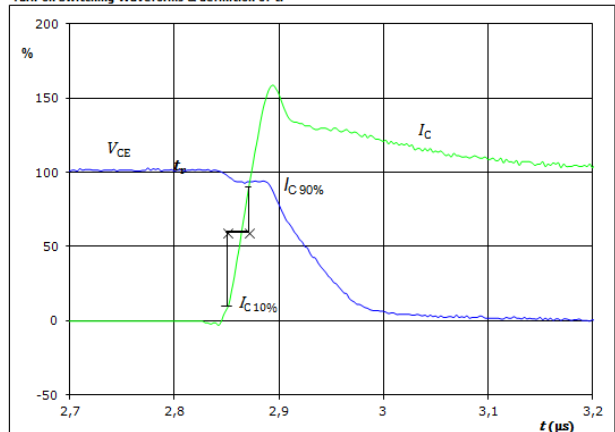
Turn-off Switching Waveforms & definition of t_f



| | | |
|-------------------------|-------|---------------|
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 15 | A |
| $t_f =$ | 0,091 | μs |

Figure 4. IGBT

Turn-on Switching Waveforms & definition of t_r

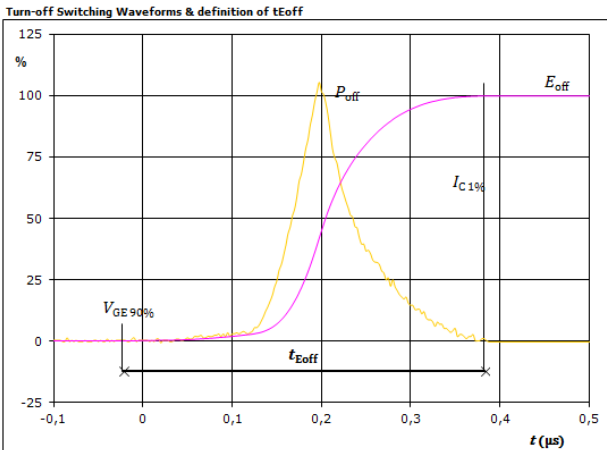


| | | |
|-------------------------|-------|---------------|
| $V_{\text{C}}(100\%) =$ | 300 | V |
| $I_{\text{C}}(100\%) =$ | 15 | A |
| $t_r =$ | 0,021 | μs |



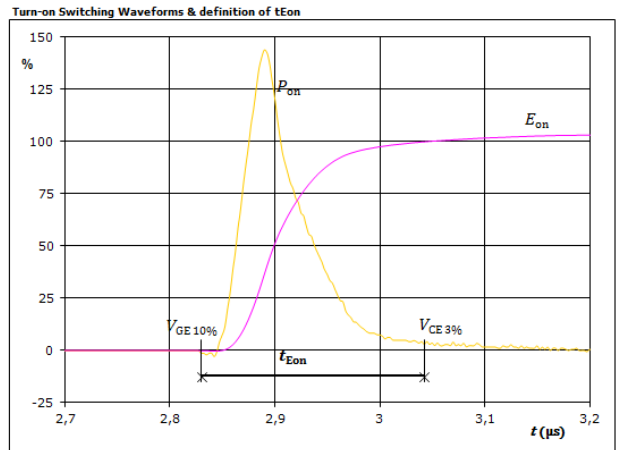
Brake Switching Characteristics

Figure 5. IGBT



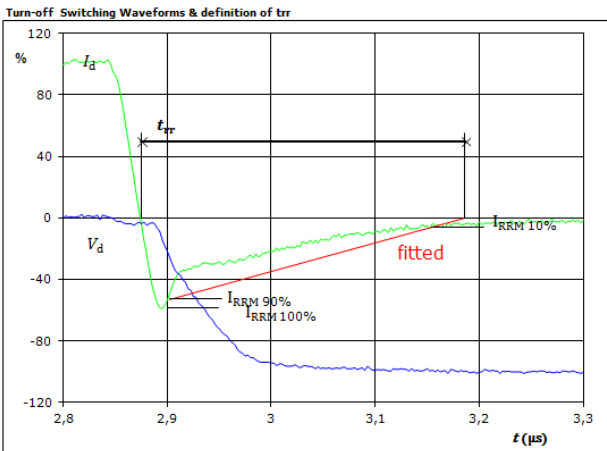
| | | |
|--------------------|------|---------|
| $P_{off}(100\%) =$ | 4,49 | kW |
| $E_{off}(100\%) =$ | 0,40 | mJ |
| $t_{Eoff} =$ | 0,40 | μs |

Figure 6. IGBT



| | | |
|-------------------|------|---------|
| $P_{on}(100\%) =$ | 4,49 | kW |
| $E_{on}(100\%) =$ | 0,41 | mJ |
| $t_{Eon} =$ | 0,21 | μs |

Figure 7. FWD

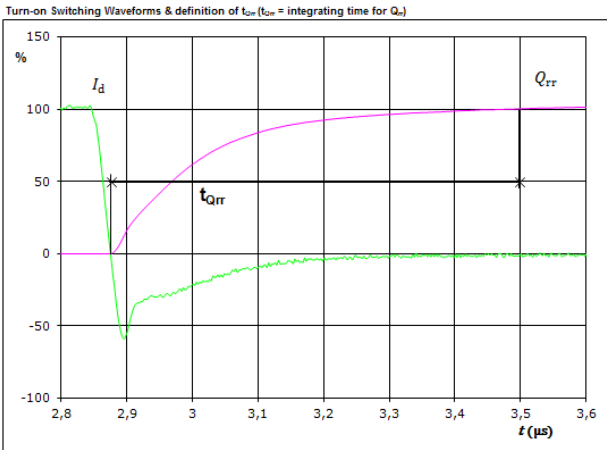


| | | |
|--------------------|-------|---------|
| $V_d(100\%) =$ | 300 | V |
| $I_d(100\%) =$ | 15 | A |
| $I_{RRM}(100\%) =$ | 9 | A |
| $t_{rr} =$ | 0,279 | μs |



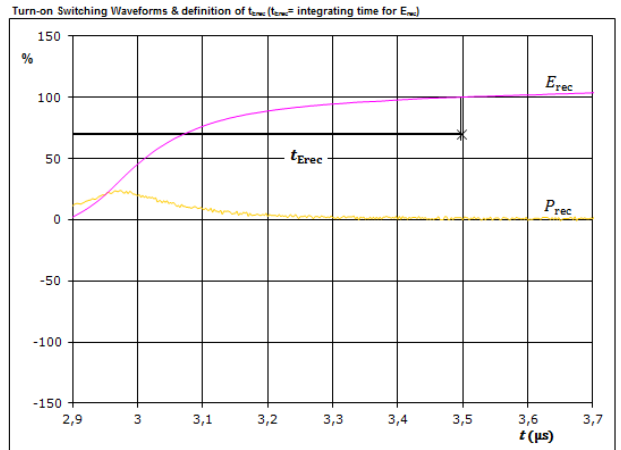
Brake Switching Characteristics

Figure 8. FWD




I_d (100%) = 15 A
 Q_{rr} (100%) = 0,96 μC
 t_{Qrr} = 0,62 μs

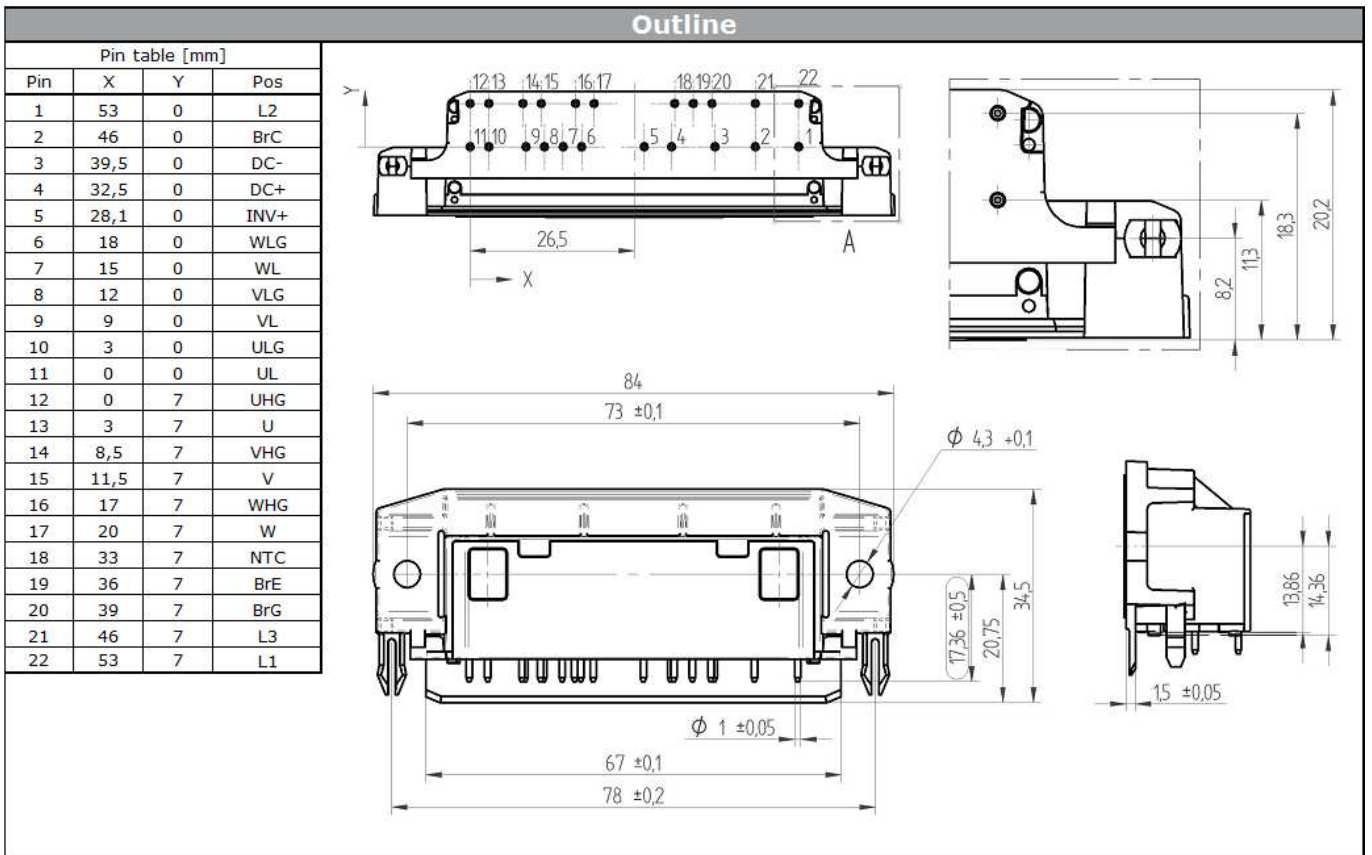
Figure 9. FWD



P_{rec} (100%) = 4,49 kW
 E_{rec} (100%) = 0,20 mJ
 t_{Erec} = 0,62 μs

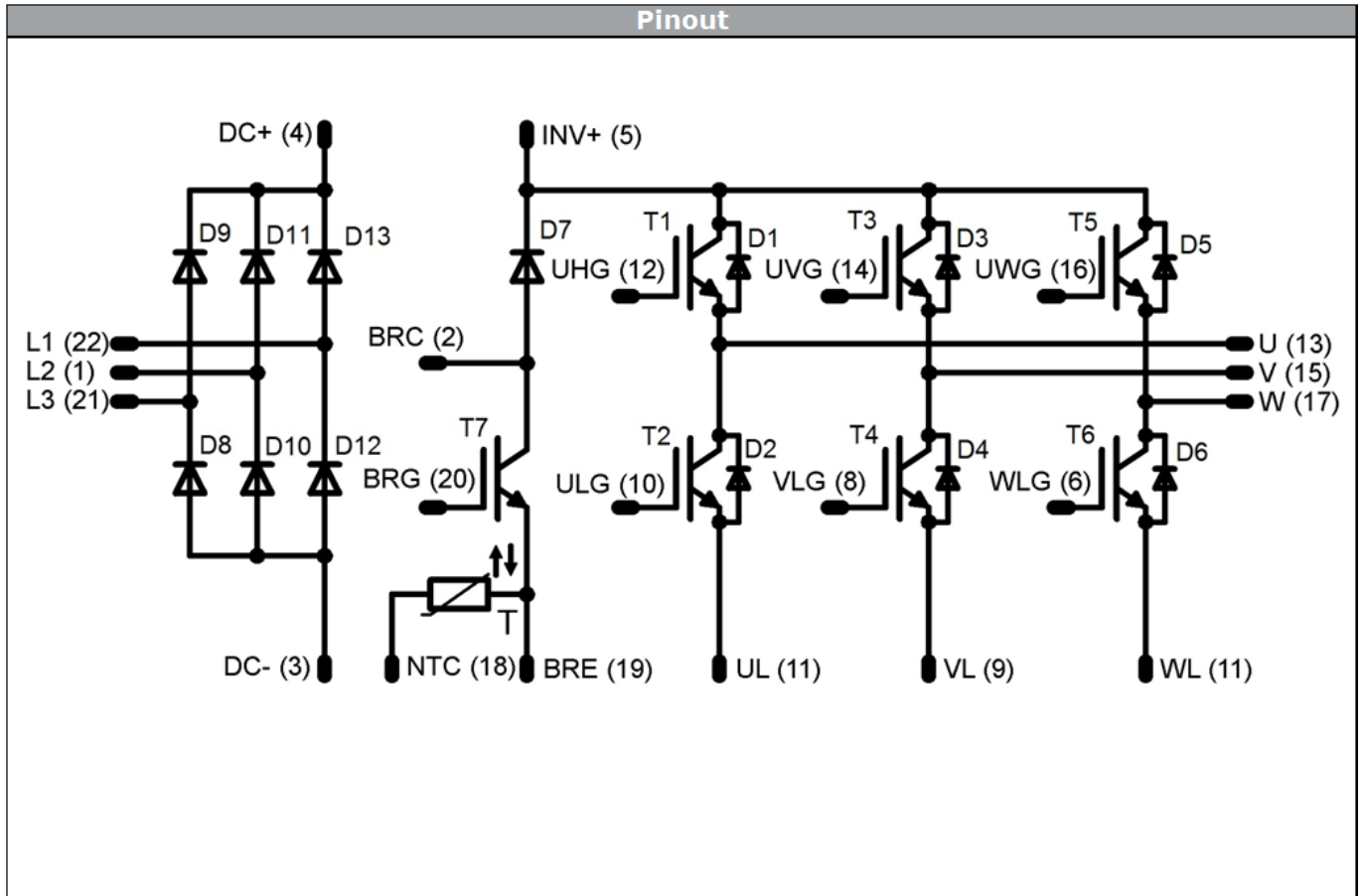


| Ordering Code & Marking | | | | | | | |
|---|----------------------|------------------|-------------------|-------------------------|------------------|-------------------|---------------|
| Version | Ordering Code | in DataMatrix as | | in packaging barcode as | | | |
| without thermal paste with solder pins | V23990-P634-A-PM | P634-A | | P634-A | | | |
| with thermal paste with solder pins | V23990-P634-A-/3/-PM | P634-A | | P634-A-/3/ | | | |
| | | | | | | | |
|  Vinco WWYY TTTTTTTTTT LLLLL SSSS | Text | Vinco | Date code | Type | UL | Lot number | Serial |
| | | Vinco | WWYY | TTTTTTTT | UL | LLLL | SSSS |
| | Datamatrix | Type | Lot number | Serial | Date code | | |
| | | TTTTTTTT | LLLL | SSSS | WWYY | | |





Vincotech



| Identification | | | | | |
|---------------------------|------------------|----------------|---------------|-----------------|----------------|
| ID | Component | Voltage | Curren | Function | Comment |
| T1,T2,T3,T4,T5,T6 | IGBT | 600V | 20A | Inverter switch | |
| D1,D2,D3,D4,D5,D6 | FWD | 600V | 20A | Inverter Diode | |
| T7 | IGBT | 600V | 15A | Brake switch | |
| D7 | FWD | 600V | 10A | Brake Diode | |
| D8,D9,D10, D11,D12,D13 | Diode | 1600V | 18A | Rectifier | |
| T | NTC | | | Thermistor | |



| Packaging instruction | | | | | |
|-----------------------------------|----|------|----------|------|--------|
| Standard packaging quantity (SPQ) | 80 | >SPQ | Standard | <SPQ | Sample |

| Handling instruction | |
|--|--|
| Handling instructions for <i>flow</i> 90 1 packages see vincotech.com website. | |

| Document No.: | Date: | Modification: | Pages |
|---------------------|--------------|---------------|-------|
| V23990-P634-A-D4-14 | 25 Mar. 2015 | | |

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.